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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	80 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc554-04i-p

PIC16C55X

NOTES:

4.0 MEMORY ORGANIZATION

4.1 Program Memory Organization

The PIC16C55X has a 13-bit program counter capable of addressing an 8 K x 14 program memory space. Only the first 512 x 14 (0000h - 01FFh) for the PIC16C554 and 2K x 14 (0000h - 07FFh) for the PIC16C557 and PIC16C558 are physically implemented. Accessing a location above these boundaries will cause a wrap-around within the first 512 x 14 spaces in the PIC16C554, or 2K x 14 space of the PIC16C558 and PIC16C557. The RESET vector is at 0000h and the interrupt vector is at 0004h (Figure 4-1, Figure 4-2).

FIGURE 4-1: PROGRAM MEMORY MAP AND STACK FOR THE PIC16C554

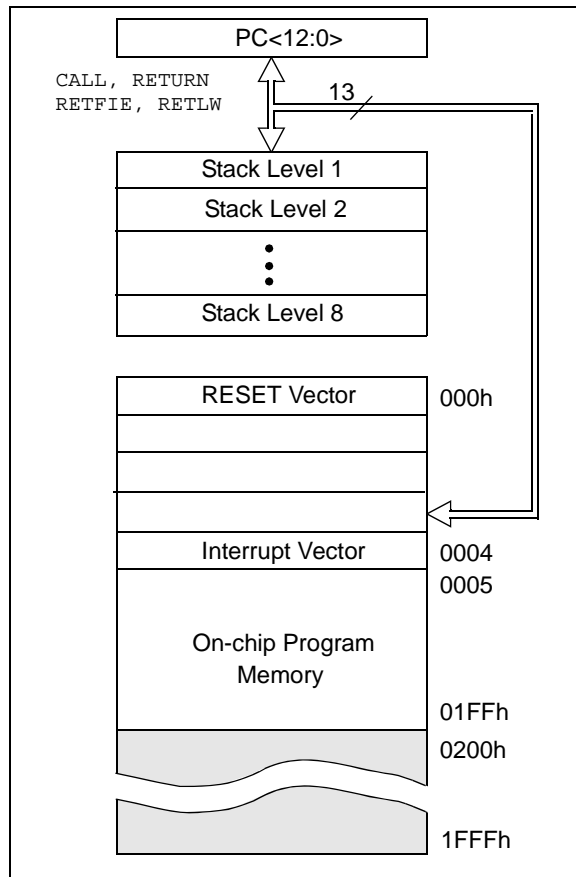
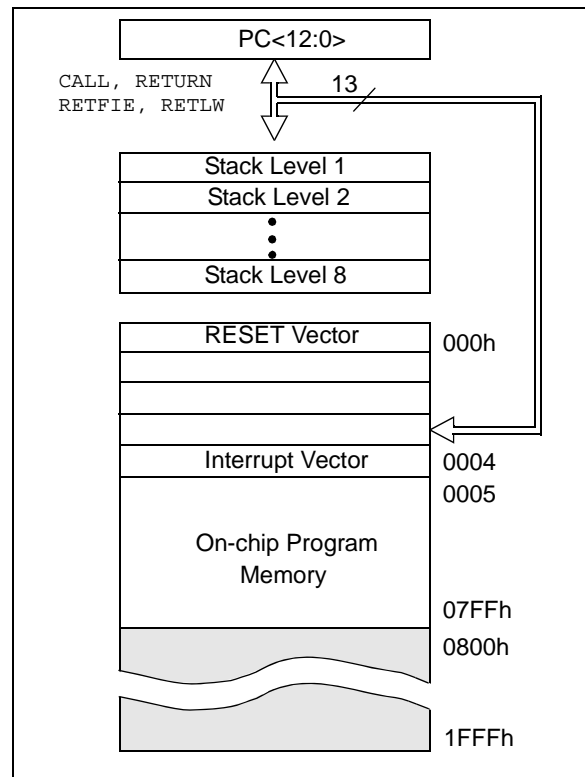


FIGURE 4-2: PROGRAM MEMORY MAP AND STACK FOR THE PIC16C557 AND PIC16C558



4.2 Data Memory Organization

The data memory (Figure 4-3 through Figure 4-5) is partitioned into two banks which contain the General Purpose Registers (GPR) and the Special Function Registers (SFR). Bank 0 is selected when the RP0 bit (STATUS <5>) is cleared. Bank 1 is selected when the RP0 bit is set. The Special Function Registers are located in the first 32 locations of each Bank. Register locations 20-6Fh (Bank 0) on the PIC16C554 and 20-7Fh (Bank 0) and A0-BFh (Bank 1) on the PIC16C558 and PIC16C557 are General Purpose Registers implemented as static RAM. Some special purpose registers are mapped in Bank 1.

4.2.1 GENERAL PURPOSE REGISTER FILE

The register file is organized as 80 x 8 in the PIC16C554 and 128 x 8 in the PIC16C557 and PIC16C558. Each can be accessed either directly or indirectly through the File Select Register, FSR (Section 4.4).

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FIGURE 4-3: DATA MEMORY MAP FOR THE PIC16C554

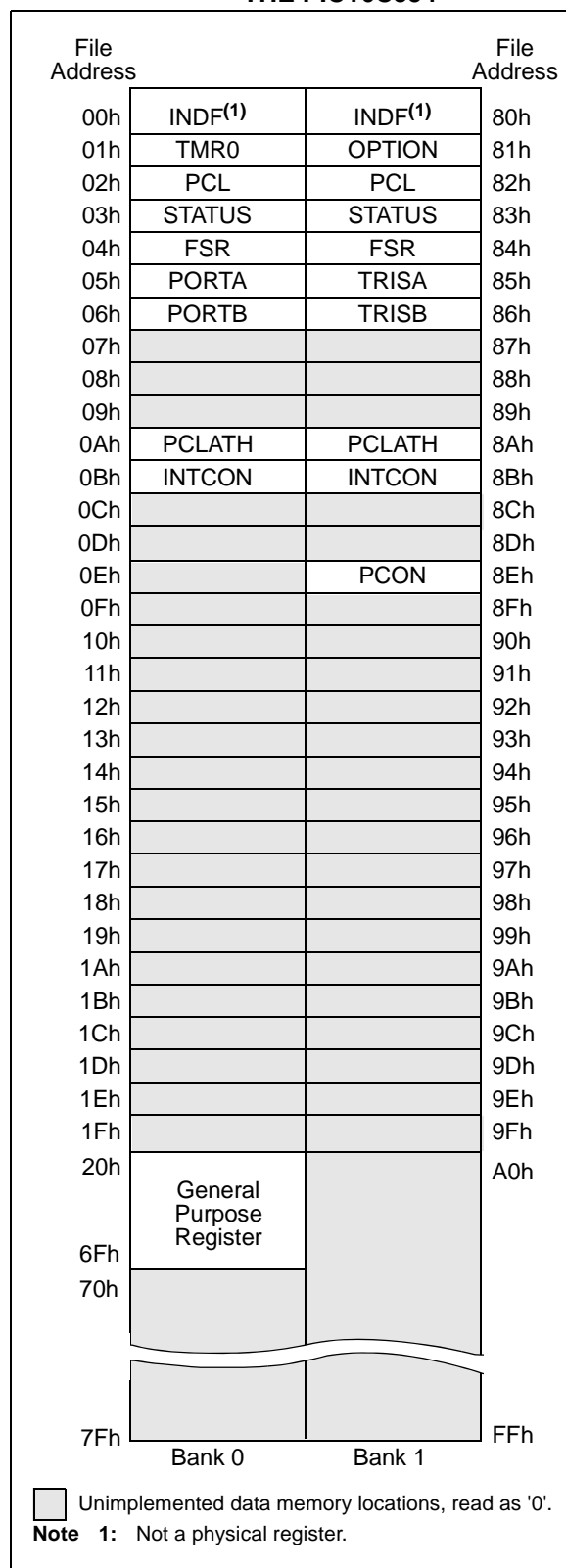
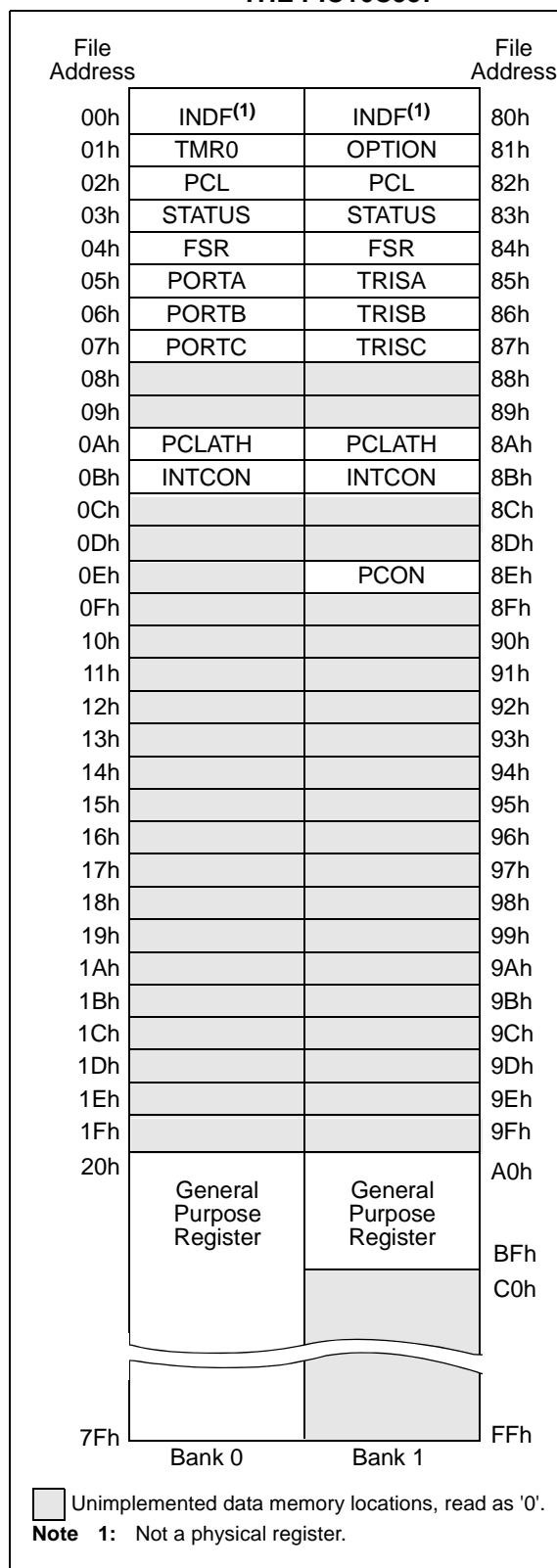


FIGURE 4-4: DATA MEMORY MAP FOR THE PIC16C557



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TABLE 5-1: PORTA FUNCTIONS

Name	Bit #	Buffer Type	Function
RA0	Bit 0	ST	Bi-directional I/O port.
RA1	Bit 1	ST	Bi-directional I/O port.
RA2	Bit 2	ST	Bi-directional I/O port.
RA3	Bit 3	ST	Bi-directional I/O port.
RA4/T0CKI	Bit 4	ST	Bi-directional I/O port or external clock input for TMR0. Output is open drain type.

Legend: ST = Schmitt Trigger input

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other RESETS
05h	PORTA	—	—	—	RA4	RA3	RA2	RA1	RA0	---x xxxx	---u uuuu
85h	TRISA	—	—	—	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	---1 1111	---1 1111

Legend: — = Unimplemented locations, read as '0', x = unknown, u = unchanged

Note 1: Shaded bits are not used by PORTA.

6.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a pre-packaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used: one with series resonance, or one with parallel resonance.

Figure 6-3 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180° phase shift that a parallel oscillator requires. The 4.7 kΩ resistor provides the negative feedback for stability. The 10 kΩ potentiometers bias the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 6-3: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

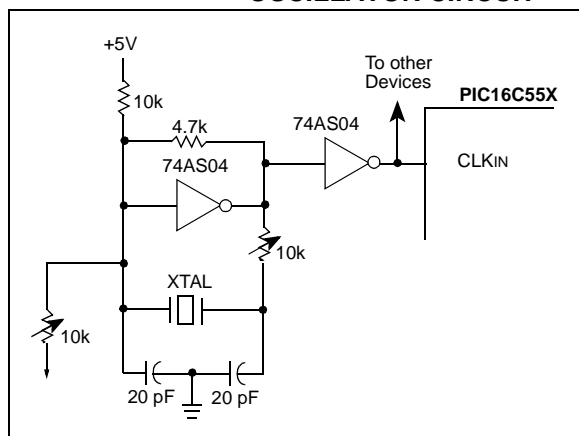
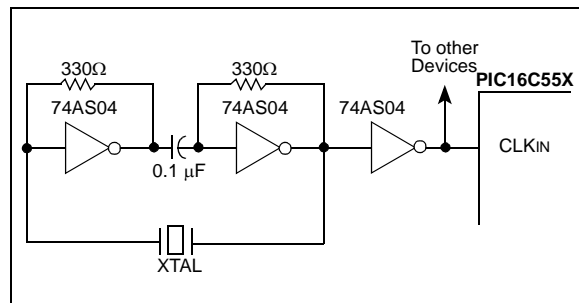


Figure 6-4 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180° phase shift in a series resonant oscillator circuit. The 330Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 6-4: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



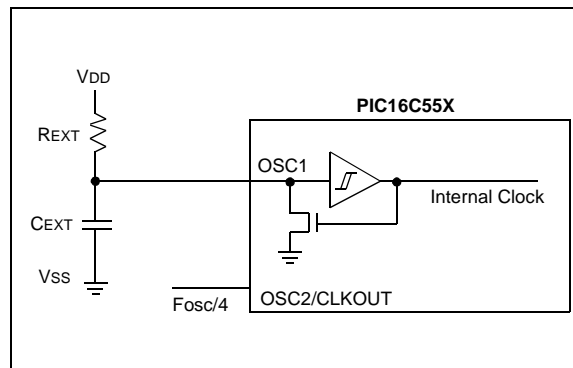
6.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (R_{EXT}) and capacitor (C_{EXT}) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low C_{EXT} values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 6-5 shows how the R/C combination is connected to the PIC16C55X. For R_{EXT} values below 2.2 kΩ, the oscillator operation may become unstable, or stop completely. For very high R_{EXT} values (e.g., 1 MΩ), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep R_{EXT} between 3 kΩ and 100 kΩ.

Although the oscillator will operate with no external capacitor (C_{EXT} = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (Figure 3-2 for waveform).

FIGURE 6-5: RC OSCILLATOR MODE



6.3 RESET

The PIC16C55X differentiates between various kinds of RESET:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$ Reset during normal operation
- $\overline{\text{MCLR}}$ Reset during SLEEP
- WDT Reset (normal operation)
- WDT wake-up (SLEEP)

Some registers are not affected in any RESET condition; their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset, on $\overline{\text{MCLR}}$ or WDT Reset and on $\overline{\text{MCLR}}$ Reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different RESET situations as indicated in Table 6-4. These bits are used in software to determine the nature of the RESET. See Table 6-6 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 6-6.

The $\overline{\text{MCLR}}$ Reset path has a noise filter to detect and ignore small pulses. See Table 10-3 for pulse width specification.

FIGURE 6-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT

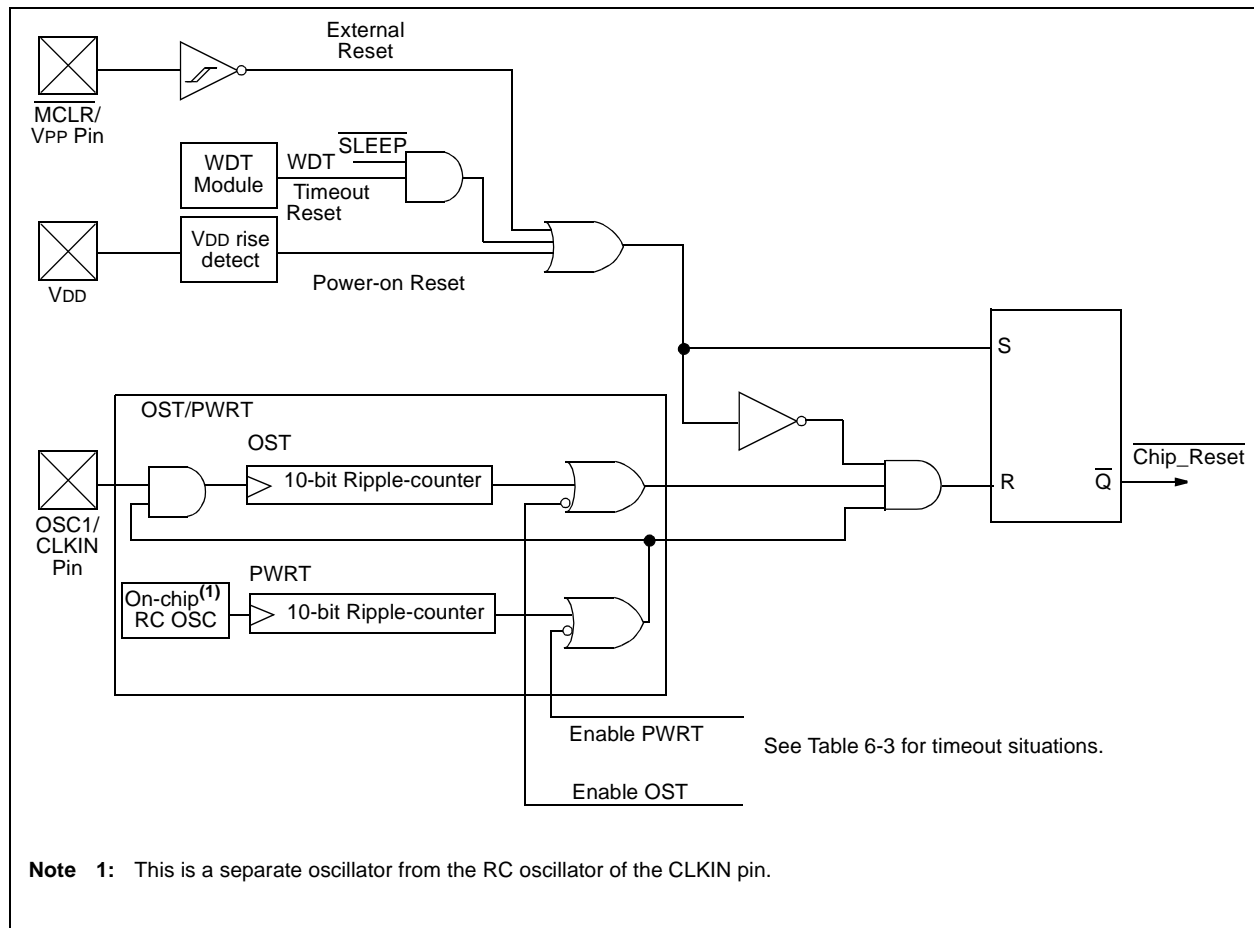


FIGURE 6-7: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE 1

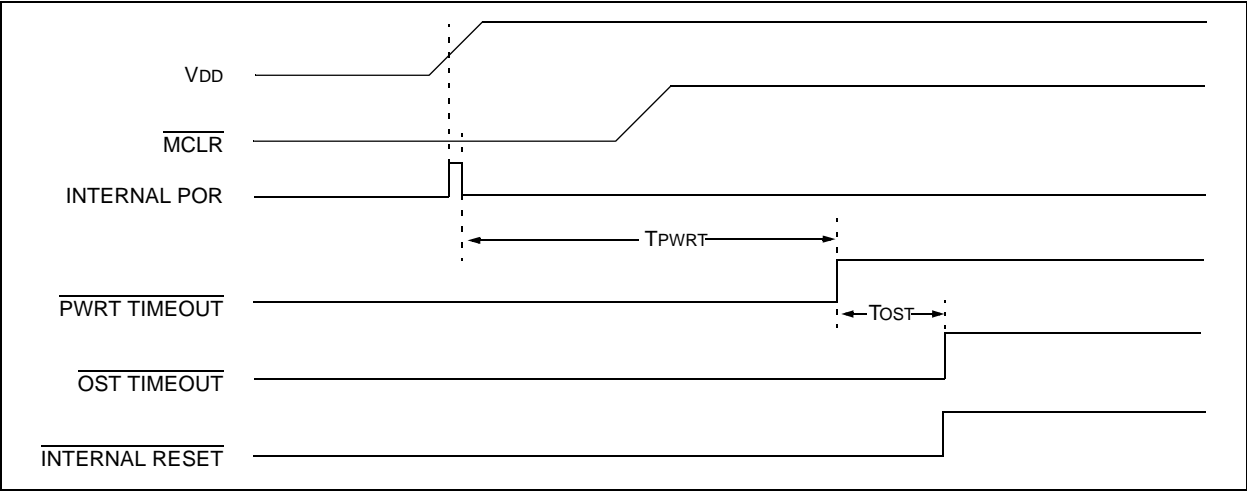
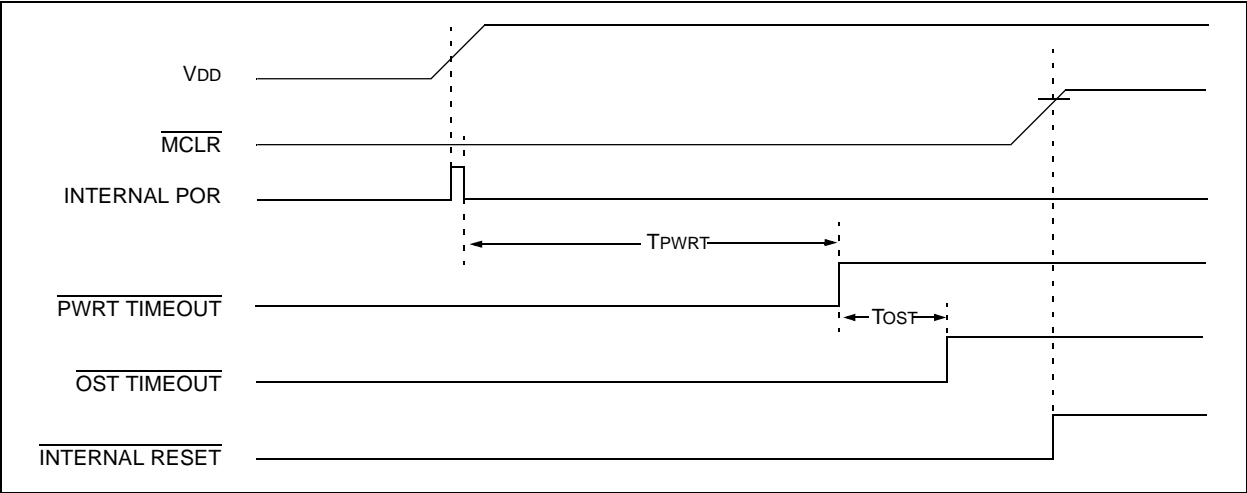


FIGURE 6-8: TIMEOUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE 2



6.6 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (e.g., W register and STATUS register). This will have to be implemented in software.

Example 6-1 stores and restores the STATUS and W registers. The user register, W_TEMP, must be defined in both banks and must be defined at the same offset from the bank base address (i.e., W_TEMP is defined at 0x20 in Bank 0 and it must also be defined at 0xA0 in Bank 1). The user register, STATUS_TEMP, must be defined in Bank 0. The Example 6-1:

- Stores the W register
- Stores the STATUS register in Bank 0
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- Restores the W register

EXAMPLE 6-1: SAVING THE STATUS AND W REGISTERS IN RAM

```
MOVWF  W_TEMP      ;copy W to TEMP
                    ;register, could be in
                    ;either bank
SWAPF  STATUS,W     ;swap STATUS to be
                    ;saved into W
BCF     STATUS,RP0   ;change to bank0
                    ;regardless of
                    ;current bank
MOVWF  STATUS_TEMP  ;save STATUS to bank0
                    ;register
:
:
:
SWAPF  STATUS_TEMP,W ;swap STATUS_TEMP
                    ;register into W, sets
                    ;bank to original state
MOVWF  STATUS       ;move W into STATUS
                    ;register
SWAPF  W_TEMP,F      ;swap W_TEMP
SWAPF  W_TEMP,W      ;swap W_TEMP into W
```

6.7 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT timeout generates a device RESET. If the device is in SLEEP mode, a WDT timeout causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 6.1).

6.7.1 WDT PERIOD

The WDT has a nominal timeout period of 18 ms, (with no prescaler). The timeout periods vary with temperature, VDD and process variations from part-to-part (see DC specs). If longer timeout periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, timeout periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The \overline{TO} bit in the STATUS register will be cleared upon a Watchdog Timer timeout.

6.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler) it may take several seconds before a WDT timeout occurs.

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FIGURE 6-13: WATCHDOG TIMER BLOCK DIAGRAM

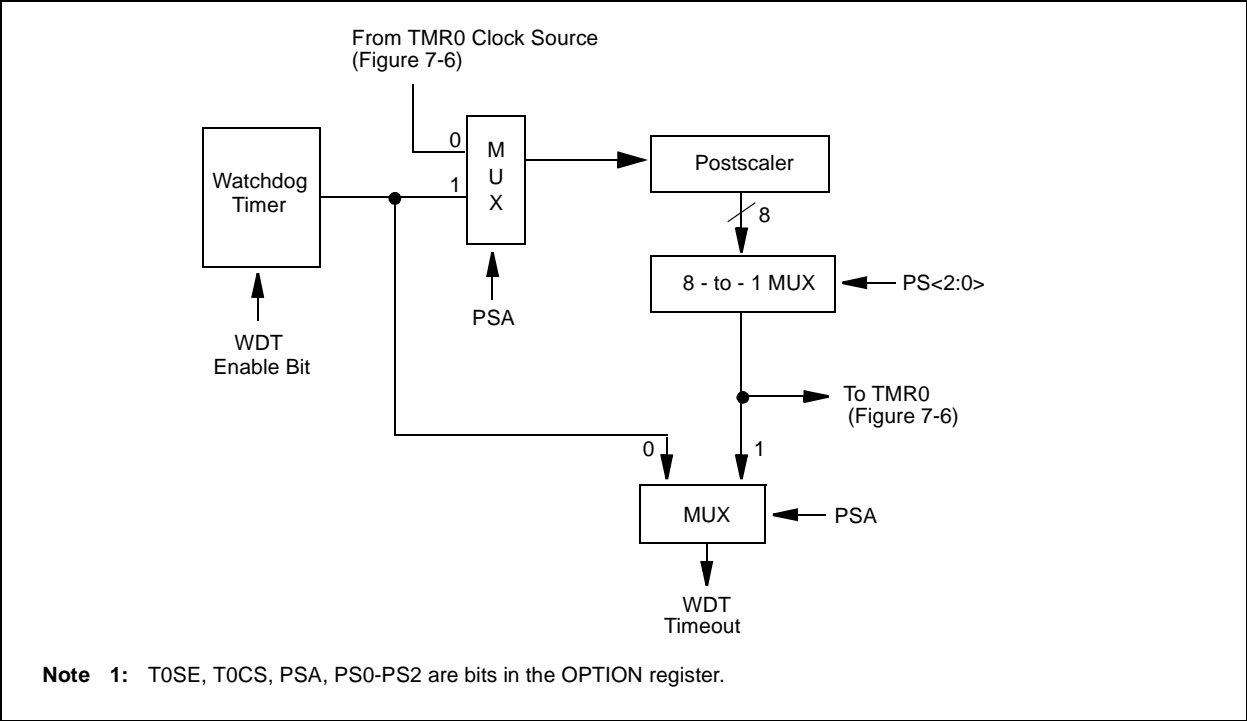


TABLE 6-7: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other RESETS
2007h	Config. bits	—	Reserved	CP1	CP0	PWRTE	WDTE	FOSC1	FOSC0		
81h	OPTION	RBP1	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, q = value depends on condition, — = unimplemented, read as '0'.
Shaded cells are not used by the Watchdog Timer.

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TABLE 8-2: PIC16C55X INSTRUCTION SET

Mnemonic, Operands	Description	Cycles	14-Bit Opcode				Status Affected	Notes
			MSb		LSb			
BYTE-ORIENTED FILE REGISTER OPERATIONS								
ADDWF f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF f	Clear f	1	00	0001	1fff	ffff	Z	2
CLRW -	Clear W	1	00	0001	0000	0011	Z	
COMF f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECf f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF f	Move W to f	1	00	0000	1fff	ffff		
NOP -	No Operation	1	00	0000	0xx0	0000		
RLF f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	C	1,2
RRF f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	C	1,2
SUBWF f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS								
BCF f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC f, b	Bit Test f, Skip if Clear	1(2)	01	10bb	bfff	ffff		3
BTFSS f, b	Bit Test f, Skip if Set	1(2)	01	11bb	bfff	ffff		3
LITERAL AND CONTROL OPERATIONS								
ADDLW k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT -	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}, \overline{PD}$	
GOTO k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE -	Return from interrupt	2	00	0000	0000	1001		
RETLW k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN -	Return from Subroutine	2	00	0000	0000	1000		
SLEEP -	Go into Standby mode	1	00	0000	0110	0011	$\overline{TO}, \overline{PD}$	
SUBLW k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

- Note 1:** When an I/O register is modified as a function of itself (e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
- Note 2:** If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.
- Note 3:** If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

8.1 Instruction Descriptions

ADDLW Add Literal and W

Syntax:	[<i>label</i>] ADDLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	$(W) + k \rightarrow (W)$				
Status Affected:	C, DC, Z				
Encoding:	<table border="1"><tr><td>11</td><td>111x</td><td>kkkk</td><td>kkkk</td></tr></table>	11	111x	kkkk	kkkk
11	111x	kkkk	kkkk		
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	ADDLW 0x15 Before Instruction W = 0x10 After Instruction W = 0x25				

ANDLW AND Literal with W

Syntax:	[<i>label</i>] ANDLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	(W) .AND. (k) → (W)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>11</td><td>1001</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1001	kkkk	kkkk
11	1001	kkkk	kkkk		
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example	ANDLW 0x5F Before Instruction W = 0xA3 After Instruction W = 0x03				

ADDWF Add W and f

Syntax:	[<i>label</i>] ADDWF <i>f</i> , <i>d</i>												
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$												
Operation:	$(W) + (f) \rightarrow (dest)$												
Status Affected:	C, DC, Z												
Encoding:	<table><tr><td>00</td><td>0111</td><td>dfff</td><td>ffff</td></tr></table>	00	0111	dfff	ffff								
00	0111	dfff	ffff										
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.												
Words:	1												
Cycles:	1												
Example	<pre>ADDWF FSR, 0</pre> <p>Before Instruction</p> <table><tr><td>W</td><td>=</td><td>0x17</td></tr><tr><td>FSR</td><td>=</td><td>0xC2</td></tr></table> <p>After Instruction</p> <table><tr><td>W</td><td>=</td><td>0xD9</td></tr><tr><td>FSR</td><td>=</td><td>0xC2</td></tr></table>	W	=	0x17	FSR	=	0xC2	W	=	0xD9	FSR	=	0xC2
W	=	0x17											
FSR	=	0xC2											
W	=	0xD9											
FSR	=	0xC2											

ANDWF AND W with f

Syntax:	[<i>label</i>] ANDWF <i>f</i> , <i>d</i>				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(W) .AND. (f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>00</td><td>0101</td><td>dfff</td><td>ffff</td></tr></table>	00	0101	dfff	ffff
00	0101	dfff	ffff		
Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	ANDWF FSR, 1 Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0x17 FSR = 0x02				

MOVF	Move f				
Syntax:	[<i>label</i>] MOVF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table><tr><td>00</td><td>1000</td><td>dfff</td><td>ffff</td></tr></table>	00	1000	dfff	ffff
00	1000	dfff	ffff		
Description:	The contents of register f is moved to a destination dependant upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.				
Words:	1				
Cycles:	1				
Example	MOVF FSR, 0 After Instruction W = value in FSR register Z = 1				

MOVWF		Move W to f			
Syntax:	[<i>label</i>] MOVWF f				
Operands:	$0 \leq f \leq 127$				
Operation:	(W) → (f)				
Status Affected:	None				
Encoding:	00	0000	1fff	ffff	
Description:	Move data from W register to register 'f'.				
Words:	1				
Cycles:	1				
Example	MOVWF OPTION				
	Before Instruction				
	OPTION = 0xFF				
	W = 0x4F				
	After Instruction				
	OPTION = 0x4F				
	W = 0x4F				

NOP		No Operation			
Syntax:	[<i>label</i>] NOP				
Operands:	None				
Operation:	No operation				
Status Affected:	None				
Encoding:	00	0000	0xx0	0000	
Description:	No operation.				
Words:	1				
Cycles:	1				
Example	NOP				

OPTION	Load Option Register				
Syntax:	[<i>label</i>] OPTION				
Operands:	None				
Operation:	(W) → OPTION				
Status Affected:	None				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0010</td></tr></table>	00	0000	0110	0010
00	0000	0110	0010		
Description:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.				
Words:	1				
Cycles:	1				
Example	<table><tr><td>To maintain upward compatibility with future PIC MCU products, do not use this instruction.</td></tr></table>	To maintain upward compatibility with future PIC MCU products, do not use this instruction.			
To maintain upward compatibility with future PIC MCU products, do not use this instruction.					

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SUBWF Subtract W from f

Syntax:	[<i>label</i>] SUBWF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	$(f) - (W) \rightarrow (\text{dest})$				
Status	C, DC, Z				
Affected:					
Encoding:	<table><tr><td>00</td><td>0010</td><td>dfff</td><td>ffff</td></tr></table>	00	0010	dfff	ffff
00	0010	dfff	ffff		
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example 1:	SUBWF REG1, 1				

Before Instruction

REG1 = 3
W = 2
C = ?

After Instruction

REG1 = 1
W = 2
C = 1; result is positive

Example 2:	Before Instruction
	REG1 = 2
	W = 2
	C = ?
	After Instruction
	REG1 = 0
	W = 2
	C = 1; result is zero

Example 3:	Before Instruction
	REG1 = 1
	W = 2
	C = ?
	After Instruction
	REG1 = 0xFF
	W = 2
	C = 0; result is negative

SWAPF Swap Nibbles in f

Syntax:	[<i>label</i>] SWAPF f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	$(f<3:0>) \rightarrow (\text{dest}<7:4>),$ $(f<7:4>) \rightarrow (\text{dest}<3:0>)$			
Status Affected:	None			
Encoding:	00	1110	dfff	ffff
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.			
Words:	1			
Cycles:	1			
Example	SWAPF REG, 0			

Before Instruction

REG1 = 0xA5

After Instruction

REG1 = 0xA5
W = 0x5A

TRIS	Load TRIS Register				
Syntax:	[<i>label</i>] TRIS f				
Operands:	$5 \leq f \leq 7$				
Operation:	(W) → TRIS register f;				
Status Affected:	None				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0fff</td></tr></table>	00	0000	0110	0fff
00	0000	0110	0fff		
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.				
Words:	1				
Cycles:	1				
Example	<table><tr><td>To maintain upward compatibility with future PIC MCU products, do not use this instruction.</td></tr></table>	To maintain upward compatibility with future PIC MCU products, do not use this instruction.			
To maintain upward compatibility with future PIC MCU products, do not use this instruction.					

XORLW Exclusive OR Literal with W

Syntax:	[<i>label</i>] XORLW <i>k</i>				
Operands:	$0 \leq k \leq 255$				
Operation:	(W) .XOR. <i>k</i> \rightarrow (W)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>11</td><td>1010</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1010	kkkk	kkkk
11	1010	kkkk	kkkk		
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example:	<pre>XORLW 0xAF</pre> <p>Before Instruction</p> <p>W = 0xB5</p> <p>After Instruction</p> <p>W = 0x1A</p>				

XORWF Exclusive OR W with f

Syntax:	[<i>label</i>] XORWF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(W) .XOR. (f) \rightarrow (dest)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>00</td><td>0110</td><td>dfff</td><td>ffff</td></tr></table>	00	0110	dfff	ffff
00	0110	dfff	ffff		
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	<pre>XORWF REG 1</pre> <p>Before Instruction</p> <p>REG = 0xAF</p> <p>W = 0xB5</p> <p>After Instruction</p> <p>REG = 0x1A</p> <p>W = 0xB5</p>				

FIGURE 10-3: VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$

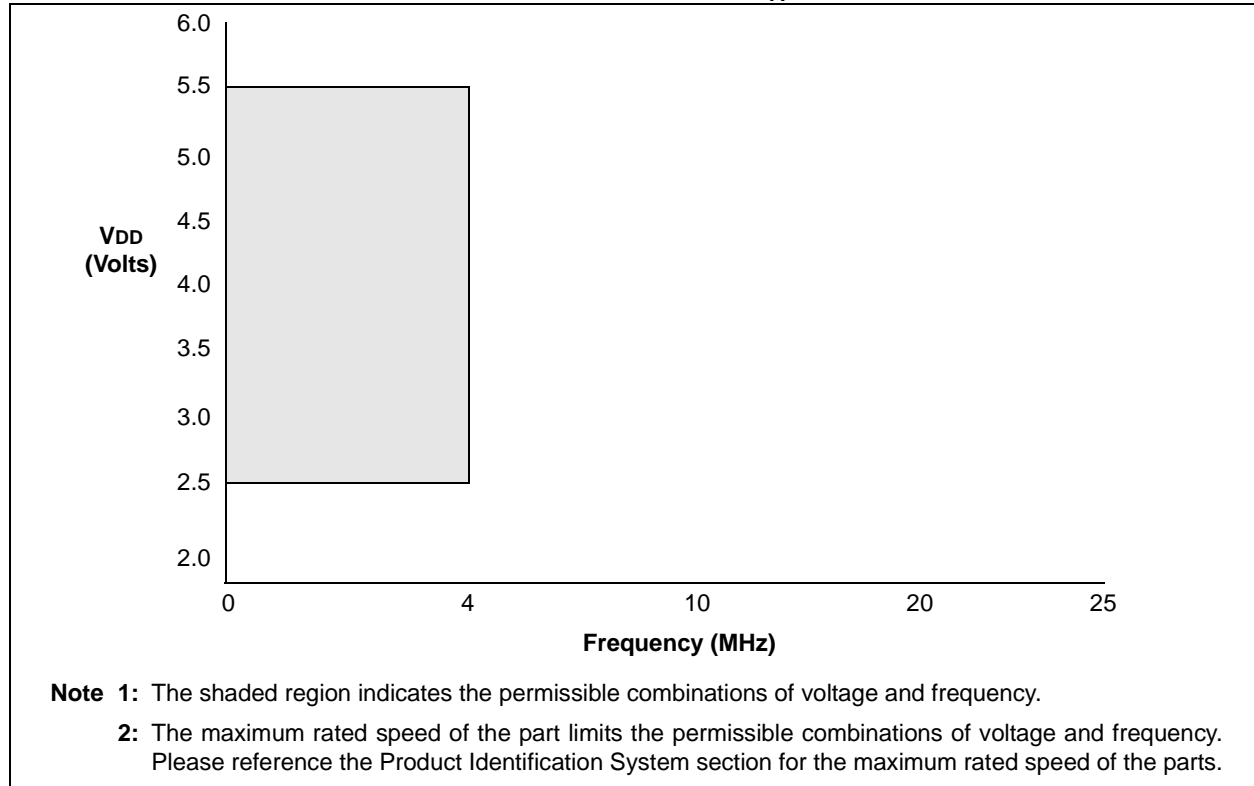
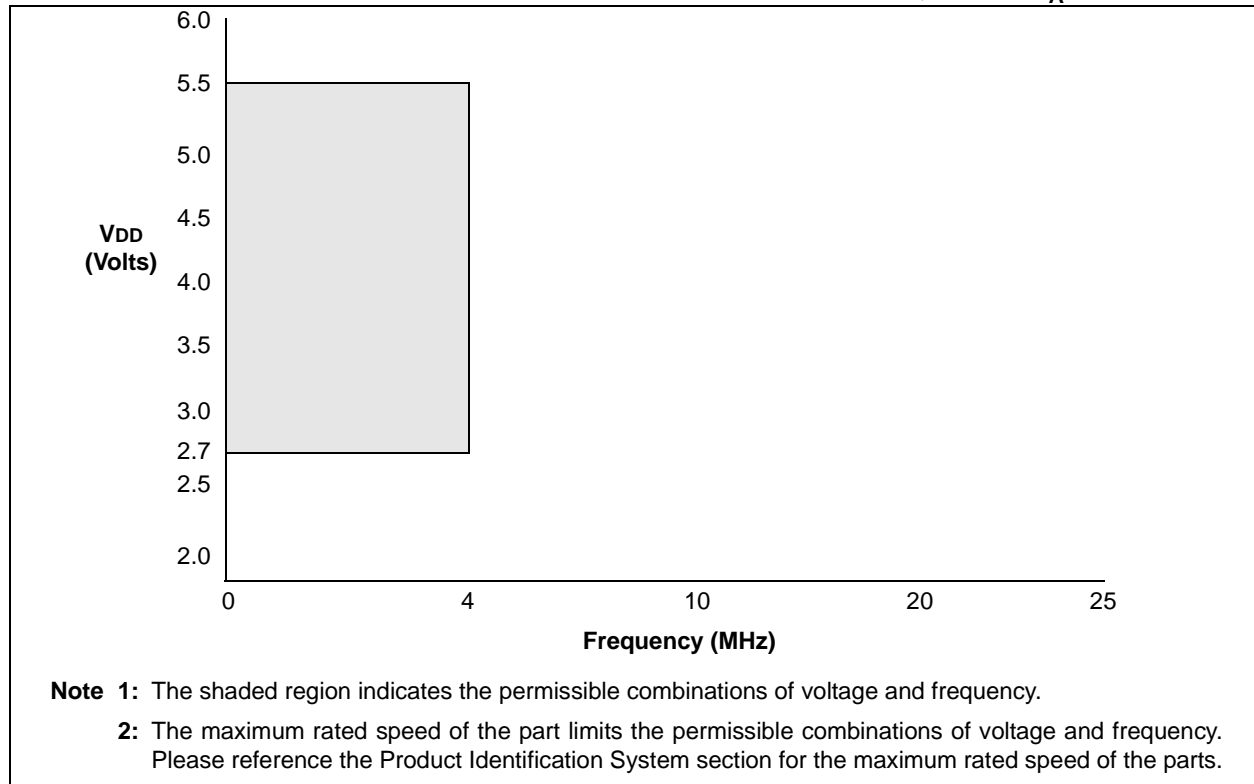


FIGURE 10-4: PIC16LC554/557/558 VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A \leq 0^{\circ}\text{C}$



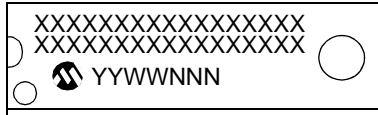
PIC16C55X

NOTES:

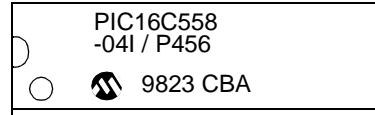
11.0 PACKAGING INFORMATION

11.1 Package Marking Information

18-Lead PDIP



Example



28-Lead PDIP



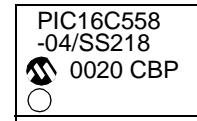
Example



20-Lead SSOP



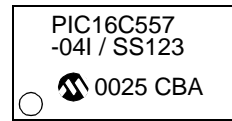
Example



28-Lead SSOP



Example

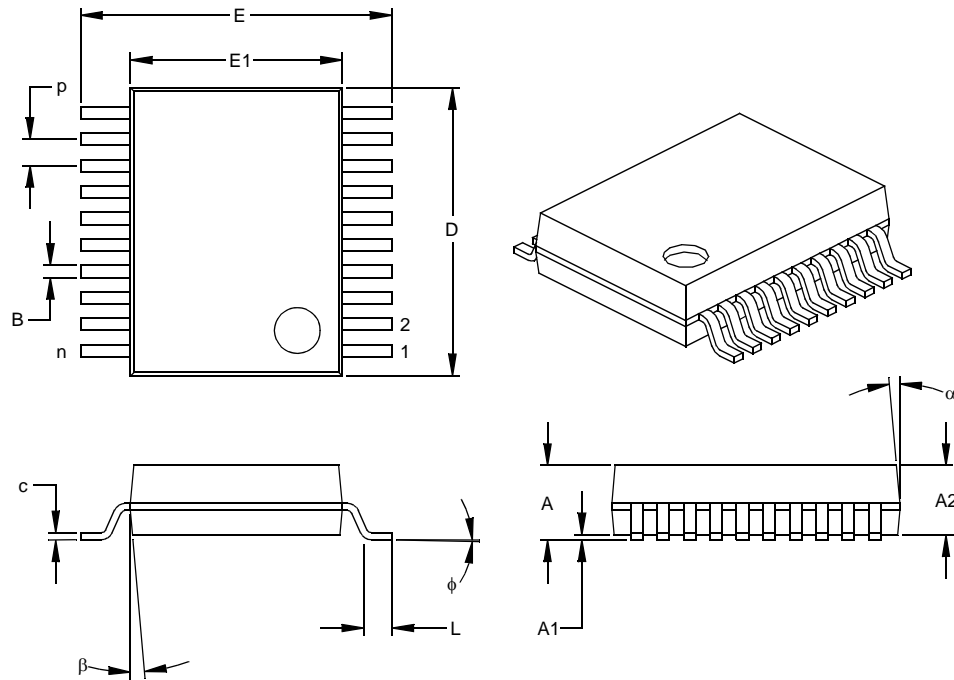


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

20-Lead Plastic Shrink Small Outline (SS) – 209 mil, 5.30 mm (SSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		20			20	
Pitch	p		.026			0.65	
Overall Height	A	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	E	.299	.309	.322	7.59	7.85	8.18
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.278	.284	.289	7.06	7.20	7.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	c	.004	.007	.010	0.10	0.18	0.25
Foot Angle	φ	0	4	8	0.00	101.60	203.20
Lead Width	B	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-150

Drawing No. C04-072

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